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O 08-10	-2001 U.S. DEPARTMENT OF COMMERCE
SON-1700 (3 \ 2001 3 \ 3 \ 2001 3 \ 3 \ 3 \ 3 \ 3 \ 3 \ 3 \ 3 \ 3 \ 3	Patent and Trademark Office
To the Honorable Commissioner of Patents and 10180	15883 <u>ral documents or copy thereof.</u>
1. Name of conveying party(ies)	2. Name and address of receiving party(ies)
Yoshihisa TAKAYAMA 7-31-6	Name: SONY CORPORATION
Additional name(s) of conveying party(ies) attached No	Internal Address:
3. Nature of conveyance:	Street Address: 7-35 KITASHINAGAWA 6-CHOME SHINAGAWA-KU
■ Assignment	City: TOKYO, JAPAN
☐ Security Agreement ☐ Change of Name	Additional name(s) & address(es) attached ☐ Yes ☒ No
Other	
Execution Date: February 24, 2000	
4. Application number(s) or patent number(s): 09/449,608	
If the document is being filed together with a new application, the e	xecution date of the application is
Additional numbers attached No	
5. Name and address of party to whom correspondence concerning document should be mailed:	6. Total number of applications and patents involved: 1
Name: Ronald P. Kananen, Esq.	7. Total fee (37 CFR 3.41) \$ 40.00
Internal Address: RADER, FISHMAN & GRAUER	☐ Enclosed
Suite 501	☑Authorized to be charged to Deposit Account
Street Address: 1233 20 th Street, NW	8. Deposit account number: 18-0013
City: Washington, D.C. Zip: 20036	(Attach duplicate copy of this page if paying by deposit account)
DO NOT USE THIS SPACE	
9. Statement and signature. To the best of my knowledge and belief, the foregoing information document. Ronald P. Kananen Name of Person Signing Signature	
7	

08/10/2001 GTON11 00000026 180013 09449604 01 FC:581 40.00 CH

Docket Number: SON-1700

ASSIGNMENT

WHEREAS, I, as a below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in

TAPE DRIVE UNIT AND RECORDING MEDIUM

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, Sony Corporation, located and doing business at 7-35 Kitashinagawa 6-Chome, Shinagawa-ku, Tokyo, JAPAN (hereinafter referenced as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

PATENT REEL: 012047 FRAME: 0673 And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow: Serial Number: 09/449,608, Filing Date: Nov.30,1999

This assignment executed on the dates indicated below.

YOSHIHISA TAKAYAMA	
Name of first inventor	Execution date of U.S. Patent Application
Kanagawa, JAPAN	
Residence of first inventor	,
Moskihisa Tobayoma.	Feb. 24. 2000
Signature of first inventor	Date of this assignment
Name of second inventor	Execution date of U.S. Patent Application
Residence of second inventor	
Signature of second inventor	Date of this assignment
Name of third inventor	Execution date of U.S. Patent Application
Residence of third inventor	
Signature of third inventor	Date of this assignment

RECORDED: 07/31/2001

PATENT REEL: 012047 FRAME: 0674